

CMOS 21-Stage Counter

High-Voltage Types (20-Volt Rating)

■ CD4045B is a timing circuit consisting of 21 counter stages, two output-shaping flip-flops, two inverter output drivers, and input inverters for use in a crystal oscillator. The CD4045B configuration provides 21 flip-flop counting stages, and two flip-flops for shaping the output waveform for a 3.125% duty cycle. Push-pull operation is provided by the inverter output drivers.

The first inverter is intended for use as a crystal oscillator/amplifier. However, it may be used as a normal logic inverter if desired. A crystal oscillator circuit can be made less sensitive to voltage-supply variations by the use of source resistors. In this device, the sources of the p and n transistors have been brought out to package terminals. If external resistors are not required, the sources must be shorted to their respective substrates (S_p to V_{DD} , S_n to V_{SS}). See Fig. 1. The first inverter in conjunction with an outboard inverter, such as 1/6 CD4069, and R_X , C_X , and R_S can also be used to construct an RC oscillator. The following data is supplied as a guide in the selection of values for R_X , R_S , and C_X used in Fig. 11:

1. R_X max = 10 M Ω with R_S = 10 M Ω and C_X = 50 pF
2. C_X max = 25 μ F with R_S = 560 k Ω and R_X = 50 k Ω

The CD4045B types are supplied in 16-lead dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline package (NSR suffix), 16-lead thin shrink small-outline package (PWR suffix), and in chip form (H suffix).

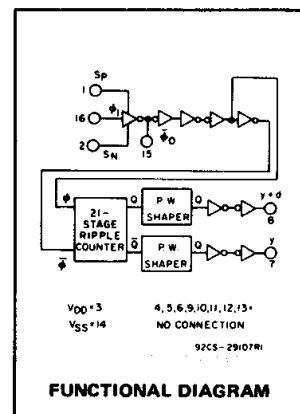
Applications:

- Digital equipment in which ultra-low dissipation and/or operation using a battery source is required.
- Accurate timing from a crystal oscillator for timing applications such as wall clocks, table clocks, automobile clocks, and digital timing references in any circuit requiring accurately timed outputs at various intervals in the counting sequence.
- Driving miniature synchronous motors, stepping motors, or external bipolar transistors in push-pull fashion.

CD4045B Types

Features:

- Very low operating dissipation <1 mW (typ.) @ V_{DD} = 5 V, $f\phi$ = 1 MHz
- Output drivers with sink or source capability 7 mA (typ.) @ V_{DD} = 5 V
- Medium speed (typ.) $f\phi$ = 25 MHz @ V_{DD} = 10 V
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, Standard Specifications for Description of 'B' Series CMOS Devices"



MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V_{DD})	 -0.5V to +20V
Voltages referenced to V_{SS} Terminal)	 -0.5V to V_{DD} + 0.5V
INPUT VOLTAGE RANGE, ALL INPUTS	 -0.5V to V_{DD} + 0.5V
DC INPUT CURRENT, ANY ONE INPUT	 $\pm$ 10mA
POWER DISSIPATION PER PACKAGE (P_D):	
For T_A = -55°C to +100°C	 500mW
For T_A = +100°C to +125°C	 Derate Linearly at 12mW/°C to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
FOR T_A = FULL PACKAGE-TEMPERATURE RANGE (All Package Types)	 100mW
OPERATING-TEMPERATURE RANGE (T_A)	 -55°C to +125°C
STORAGE TEMPERATURE RANGE (T_{stg})	 -85°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):	
At distance 1/16 $\pm$ 1/32 inch (1.59 $\pm$ 0.79mm) from case for 10s max	 +265°C

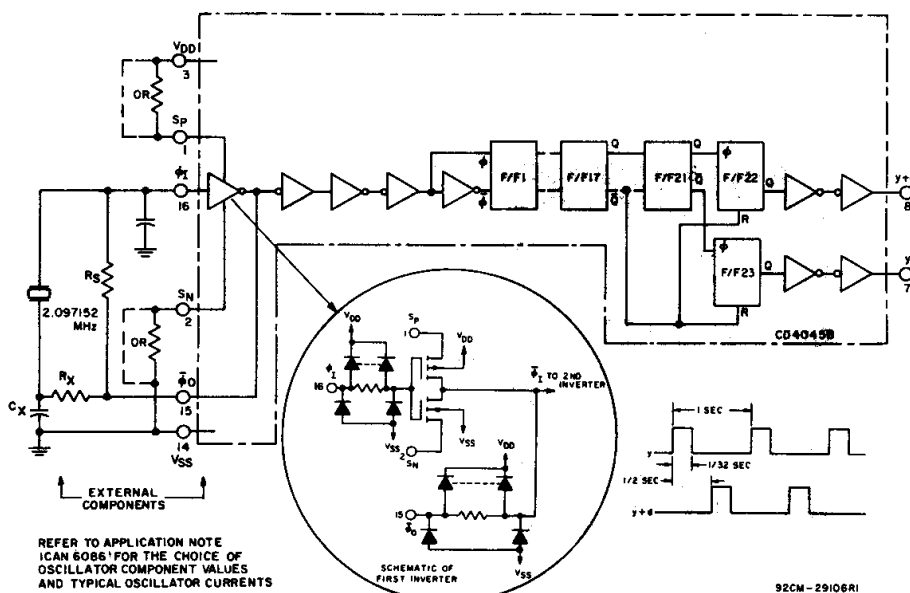


Fig. 1 – CD4045B and outboard components in a typical 21-stage counter application.

CD4045B Types

STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							UNITS
	V _O (V)	V _{IN} (V)	V _{DD} (V)	-55	-40	+85	+125	+25			
								Min.	Typ.	Max.	
Quiescent Device Current, I _{DD} Max.	—	0,5	5	5	5	150	150	—	0.04	5	μA
	—	0,10	10	10	10	300	300	—	0.04	10	
	—	0,15	15	20	20	600	600	—	0.04	20	
	—	0,20	20	100	100	3000	3000	—	0.08	100	
Output Low (Sink) Current I _{OL} Min.	0.4	0,5	5	4.5	4.3	2.9	2.5	3.6	7	—	mA
	0.5	0,10	10	11.2	10.5	7.7	6.3	9.1	18	—	
	1.5	0,15	15	29.4	28	19.6	16.8	23.8	47	—	
Output High (Source) Current, I _{OH} Min.	4.6	0,5	5	-4.5	-4.3	-2.9	-2.5	-3.6	-7	—	mA
	9.5	0,10	10	-11.2	-10.5	-7.7	-6.3	-9.1	-18	—	
	13.5	0,15	15	-29.4	-28	-19.6	-16.8	-23.8	-47	—	
Pin 15 Output Low and High Current, I _{OL} , I _{OH}	0.4,4.6	0,5	5	—				±0.1	±0.18	—	mA
	0.5,9.5	0,10	10	—				±0.2	±0.3	—	
	1.5,13.5	0,15	15	—				±0.5	±1	—	
Output Voltage: Low-Level, V _{OL} Max.	—	0,5	5	0.05				—	—	0.05	V
	—	0,10	10	0.05				—	—	0.05	
	—	0,15	15	0.05				—	—	0.05	
Output Voltage: High-Level, V _{OH} Min.	—	0,5	5	4.95				4.95	5	—	V
	—	0,10	10	9.95				9.95	10	—	
	—	0,15	15	14.95				14.95	15	—	
Input Low Voltage V _{IL} Max.	0.5,4.5	—	5	1.5				—	—	1.5	V
	1,9	—	10	3				—	—	3	
	1.5,13.5	—	15	4				—	—	4	
Input High Voltage, V _{IH} Min.	0.5,4.5	—	5	3.5				3.5	—	—	V
	1,9	—	10	7				7	—	—	
	1.5,13.5	—	15	11				11	—	—	
Input Current I _{IN} Max.	—	0,18	18	±0.1	±0.1	±1	±1	—	±10 ⁻⁵	±0.1	μA

RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges

CHARACTERISTIC	V _{DD} (V)	LIMITS		UNITS
		Min.	Max.	
Supply-Voltage Range (For T _A = Full Package-Temperature Range)	—	3	18	V
Minimum Input-Pulse Width, t _W	5	—	100	ns
	10	—	50	
	15	—	40	
Maximum Input-Pulse Frequency, f _φ (External Pulse Source)	5	5	—	MHz
	10	12	—	
	15	15	—	

3
COMMERCIAL CMOS
HIGH VOLTAGE ICs

CD4045B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$; Input $t_r, t_f = 20\text{ ns}$,
 $C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$

CHARACTERISTIC	TEST CONDITIONS	V_{DD} V	LIMITS			UNITS
			Min.	Typ.	Max.	
Propagation Delay Time: ϕ_1 to y or y+d out t_{PHL}, t_{PLH}		5 10 15	— — —	2.2 0.9 0.65	5.5 2.7 2	μs
Transition Time: t_{THL}, t_{TLH}		5 10 15	— — —	25 13 10	50 25 20	ns
Minimum Input-Pulse Width t_W		5 10 15	— — —	50 25 20	100 50 40	ns
Input-Pulse Rise or Fall Time: t_r, t_f		5 10 15	— — —	— — —	500 500 500	μs
Maximum Input-Pulse Frequency: (External Pulse Source) f_ϕ		5 10 15	5 12 15	10 25 30	— — —	MHz
Input Capacitance, C_{IN}	Any Input		—	5	7.5	pF
Variation of Output Frequency (Unit-to-Unit)	$f = 5\text{ MHz}$	5 10 15	— — —	0.05 0.03 0.1	— — —	%
RC Oscillator Operation						
Maximum Oscillator Frequency (See Fig. 11) f_{osc}	$R_X = 50\text{ k}\Omega$, $R_S = 560\text{ k}\Omega$, $C_X = 50\text{ pF}$	5 10 15	45 45 45	60 60 60	75 75 75	kHz

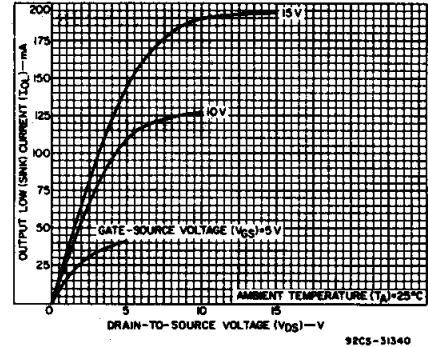


Fig. 2 - Typical output low (sink) current characteristics.

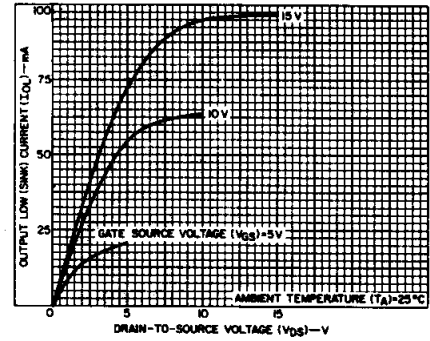


Fig. 3 - Minimum output low (sink) current characteristics.

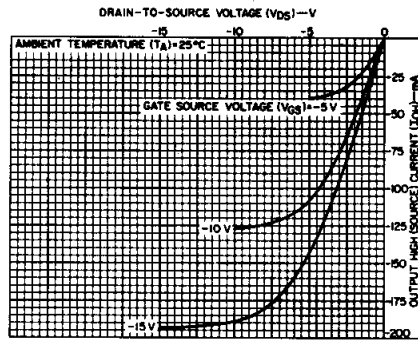


Fig. 4 - Typical output high (source) current characteristics.

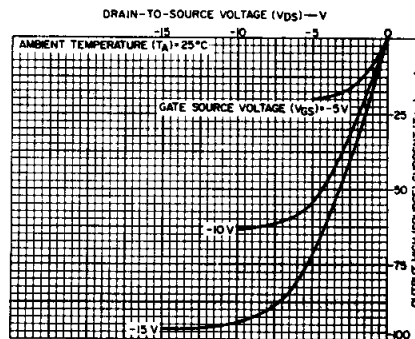


Fig. 5 - Minimum output high (source) current characteristics.

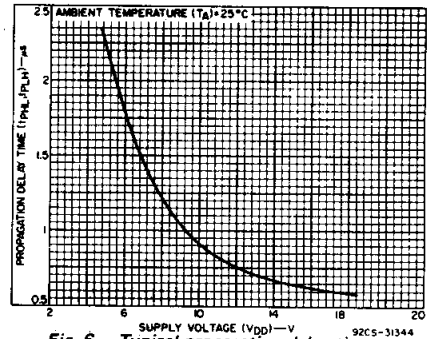


Fig. 6 - Typical propagation delay time as a function of supply voltage (ϕ_1 to y or y + d out vs. V_{DD}).

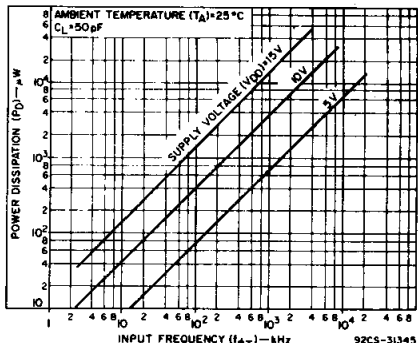


Fig. 7 - Typical power dissipation as a function of input frequency (21 counting stages).

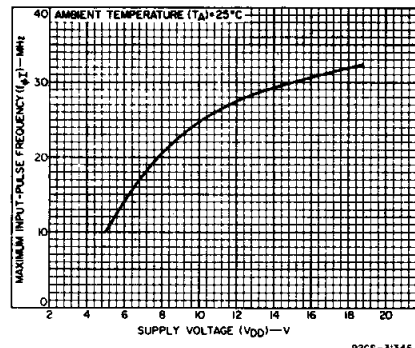


Fig. 8 - Typical maximum input-pulse frequency as a function of supply voltage.

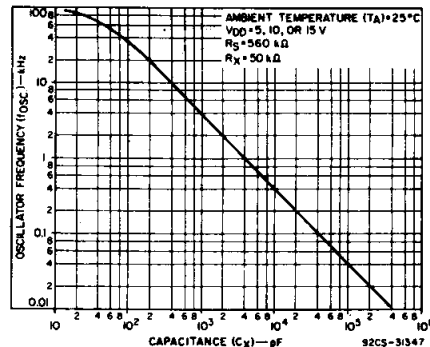


Fig. 9 - Typical RC oscillator frequency as a function of capacitance (C_X), See Fig. 11.

CD4045B Types

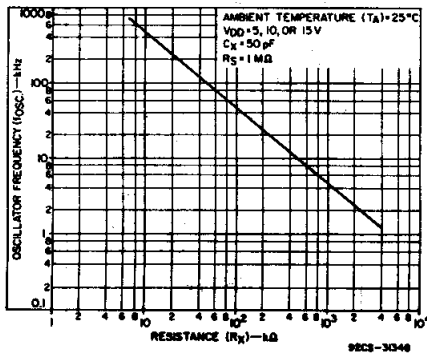


Fig. 10 - Typical RC oscillator frequency as a function of resistance (R_X). See Fig. 11.

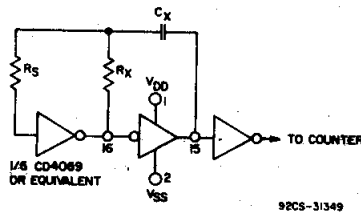


Fig. 11 - Typical RC circuit.

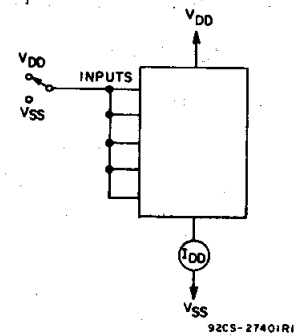


Fig. 12 - Quiescent-device-current test circuit.

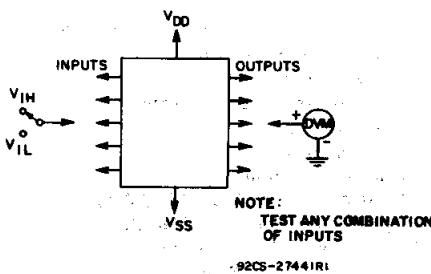


Fig. 13 - Noise-immunity test circuit.

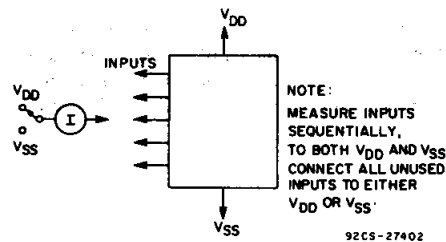


Fig. 14 - Input-leakage-current test circuit.

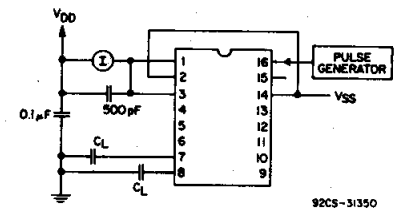
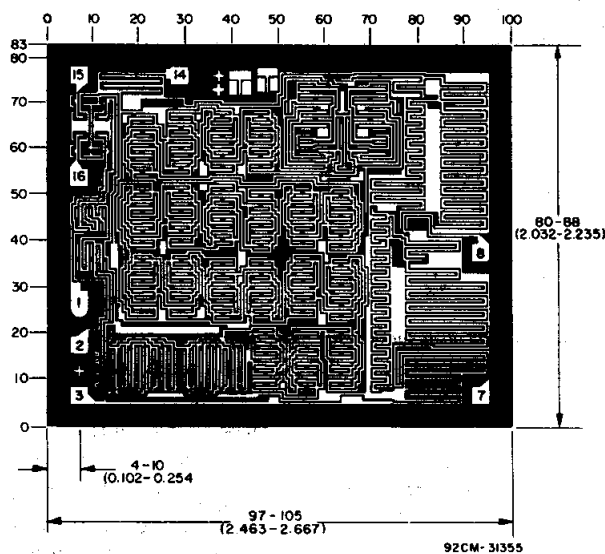


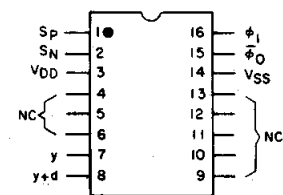
Fig. 15 - Dynamic power dissipation test circuit.



Chip dimensions and pad layout for CD4045B

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

TERMINAL DIAGRAM Top View



92CS-24478R2

NC = NO CONNECTION

NOTE Observe power-supply terminal connections, V_{DD} is terminal No. 3 and V_{SS} is terminal No. 14 (not 16 and 8 respectively, as in other CD4000B Series 16-lead devices).

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265